

18dB High Gain Low Noise Amplifier for LTE Lowband

Features

Operating frequencies: 600 - 1000 MHz

• Insertion power gain: 18.5 dB

Insertion Loss in bypass mode: 2.7 dB

Low noise figure: 0.7 dB

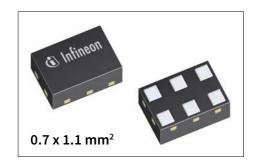
Low current consumption: 8.2 mA

Multi-state control: Bypass- and high gain-Mode

Ultra small TSNP-6-10 leadless package

RF output internally matched to 50 Ohm

Low external component count



Application

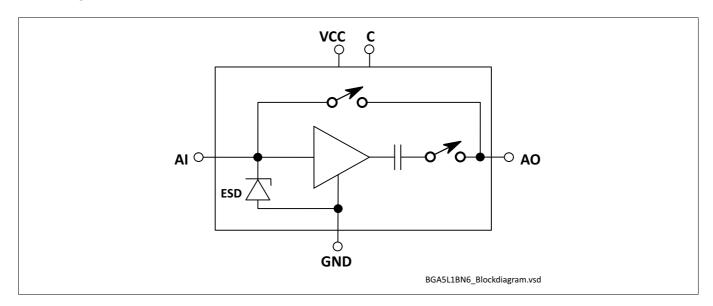
The LTE data rate can be significantly improved by using the Low Noise Amplifier. The integrated bypass function increases the overall system dynamic range and leads to more flexibility in the RF front-end.

In high gain mode the LNA offers best Noise Figure to ensure high data rates even on the LTE cell edge. Closer to the basestation the bypass mode can be activated reducing current consumption.

Product Validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Block diagram



18dB High Gain Low Noise Amplifier for LTE Lowband



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Features

1 **Features**

Insertion power gain: 18.5 dB

Insertion Loss in bypass mode: 2.7 dB

Low noise figure: 0.7 dB

Low current consumption: 8.2 mA

Operating frequencies: 600 - 1000 MHz

Multi-state control: Bypass- and High gain-Mode

Supply voltage: 1.5 V to 3.6 V

Ultra small TSNP-6-10 leadless package (footprint: 0.7 x 1.1 mm²)

B9HF Silicon Germanium technology

RF output internally matched to 50 Ohm

Low external component count

Pb-free (RoHS compliant) package





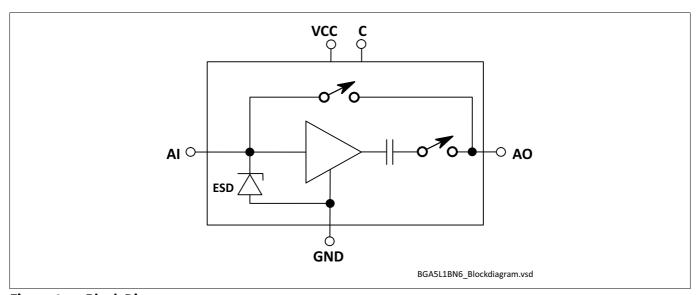


Figure 1 **Block Diagram**

Product Name	Marking	Package
BGA5L1BN6	3	TSNP-6-10

18dB High Gain Low Noise Amplifier for LTE Lowband



Features

Description

The BGA5L1BN6 is a front-end low noise amplifier for LTE which covers a wide frequency range from 600 MHz to 1000 MHz. The LNA provides 18.5 dB gain and 0.7 dB noise figure at a current consumption of 8.2 mA in the application configuration described in **Chapter 4**. In bypass mode the LNA provides an insertion loss of 2.7 dB. The BGA5L1BN6 is based upon Infineon Technologies' B9HF Silicon Germanium technology. It operates from 1.5 V to 3.6 V supply voltage. The device features a single-line two-state control (Bypass- and High gain-Mode). OFF-state can be enabled by powering down VCC.

Pin Definition and Function

Table 1 Pin Definition and Function

Pin No.	Name	Function
1	GND	Ground
2	VCC	DC supply
3	AO	LNA output
4	GND	Ground
5	Al	LNA input
6	С	Control

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Maximum Ratings

2 Maximum Ratings

Table 2 Maximum Ratings

Parameter	Symbol		Value	Unit	Note or	
		Min.	Тур.	Max.		Test Condition
Voltage at pin VCC	$V_{\rm CC}$	-0.3	_	3.6	V	1)
Voltage at pin Al	V_{AI}	-0.3	_	0.9	V	_
Voltage at pin AO	V_{AO}	-0.3	-	V _{CC} + 0.3	V	_
Voltage at pin C	V _C	-0.3	_	V _{CC} + 0.3	V	_
Voltage at pin GND	$V_{\sf GND}$	-0.3	_	0.3	V	_
Current into pin VCC	I _{cc}	_	-	16	mA	_
RF input power	P _{IN}	_	_	+25	dBm	_
Total power dissipation, $T_S < 148 ^{\circ}C^{2)}$	P _{tot}	-	-	60	mW	-
Junction temperature	T_{J}	_	_	150	°C	_
Ambient temperature range	T_{A}	-40	_	85	°C	_
Storage temperature range	$T_{\rm STG}$	-55	-	150	°C	_

¹⁾ All voltages refer to GND-Node unless otherwise noted

Attention: Stresses above the max. values listed here may cause permanent damage to the device.

Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. Exposure to conditions at or below absolute maximum rating but above the specified maximum operation conditions may affect device reliability and life time. Functionality of the device might not be given under these conditions.

²⁾ $T_{\rm S}$ is measured on the ground lead at the soldering point



Electrical Characteristics

Electrical Characteristics 3

Electrical Characteristics V_{CC} = 1.8V¹⁾

 $T_{\rm A}$ = 25 °C, $V_{\rm CC}$ = 1.8 V, $V_{\rm C,BP}$ = 1.8 V, $V_{\rm C,OFF}$ = 0 V, f = 600 - 1000 MHz

Parameter	Symbol		Value	5	Unit	Note or Test Condition	
		Min.	Тур.	Max.			
Supply voltage	$V_{\rm CC}$	1.5	1.8	3.6	٧	-	
Control voltages	V _C	1.0	_	$V_{\rm CC}$	V	High gain mode	
		0	_	0.4	٧	Bypass mode	
Supply current	I _{CC}	-	8.2	9.7	mA	High gain mode	
		-	85	120	μΑ	Bypass mode	
Insertion power gain	$ S_{21} ^2$	17.0	18.5	20.0	dB	High gain mode	
f = 840 MHz		-3.9	-2.7	-1.5	dB	Bypass mode	
Noise figure ²⁾	NF	-	0.7	1.2	dB	High gain mode	
$f = 840 \text{ MHz}, Z_{S} = 50 \Omega$		-	2.7	3.9	dB	Bypass mode	
nput return loss³)	RL _{IN}	7	10	_	dB	High gain mode	
= 840 MHz		8	11	_	dB	Bypass mode	
Output return loss³)	RL _{OUT}	10	19	_	dB	High gain mode	
f = 840 MHz		5	8	_	dB	Bypass mode	
Reverse isolation ³⁾	$1/ S_{12} ^2$	22	29	_	dB	High gain mode	
f = 840 MHz		1.5	2.7	_	dB	Bypass mode	
Power on time ⁴⁾⁶⁾	t_{S}	-	3	7	μs	OFF to High gain mode	
nband input 1dB-compression	IP _{1dB}	-24	-20	_	dBm	High gain mode	
point, <i>f</i> = 840 MHz ³⁾		-2	2	_	dBm	Bypass mode	
nband input 3 rd -order	IIP ₃	-12	-7	_	dBm	High gain mode	
ntercept point ³⁾⁵⁾ $f_1 = 840 \text{ MHz}, f_2 = f_1 + / - 1 \text{ MHz}$		6	11	-	dBm	Bypass mode	
Stability ⁶⁾	k	>1	_	_		f = 20 MHz 10 GHz	

- 1) Based on the application described in **Chapter 4**
- 2) PCB losses are subtracted
- 3) Verification based on AQL; not 100% tested in production
- 4) Gain changed to >90% of gain difference (in dB)
- 5) Input power HG = -30 dBm for each tone; input power BP = -10 dBm for each tone
- 6) Guaranteed by device design; not tested in production

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Electrical Characteristics

Table 4 Electrical Characteristics $V_{cc} = 2.8V^{1}$

 $T_{\rm A}$ = 25 °C, $V_{\rm CC}$ = 2.8 V, $V_{\rm C,BP}$ = 2.8 V, $V_{\rm C,OFF}$ = 0 V, f = 600 - 1000 MHz

Parameter	Symbol		Value	S	Unit	Note or Test Condition		
		Min.	Тур.	Max.				
Supply voltage	$V_{\rm cc}$	1.5	2.8	3.6	٧	-		
Control voltages	V _C	1.0	_	$V_{\rm CC}$	٧	High gain mode		
		0	_	0.4	٧	Bypass mode		
Supply current	I _{CC}	_	9.4	10.9	mA	High gain mode		
		-	87	120	μΑ	Bypass mode		
nsertion power gain	$ S_{21} ^2$	17.2	18.7	20.2	dB	High gain mode		
f = 840 MHz		-3.9	-2.7	-1.5	dB	Bypass mode		
Noise figure ²⁾	NF	-	0.75	1.25	dB	High gain mode		
$f = 840 \text{ MHz}, Z_{S} = 50 \Omega$		-	2.7	3.9	dB	Bypass mode		
nput return loss³)	RL _{IN}	8	11	_	dB	High gain mode		
f = 840 MHz		8	11	_	dB	Bypass mode		
Output return loss³)	RL _{OUT}	10	18	_	dB	High gain mode		
f = 840 MHz		5	8	_	dB	Bypass mode		
Reverse isolation ³⁾	$1/ S_{12} ^2$	22	29	_	dB	High gain mode		
f = 840 MHz		1.5	2.7	_	dB	Bypass mode		
Power on time ⁴⁾⁶⁾	t_{S}	-	3	7	μs	OFF to High gain mode		
nband input 1dB-compression	IP _{1dB}	-24	-20	_	dBm	High gain mode		
ooint, <i>f</i> = 840 MHz ³⁾		-2	2	_	dBm	Bypass mode		
nband input 3 rd -order	IIP_3	-12	-7	-	dBm	High gain mode		
ntercept point ³⁾⁵⁾ $f_1 = 840 \text{ MHz}, f_2 = f_1 + / - 1 \text{ MHz}$		6	11	-	dBm	Bypass mode		
Stability ⁶⁾	k	> 1	_	_		f = 20 MHz 10 GHz		

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Application Information

Application Information 4

Application Board Configuration

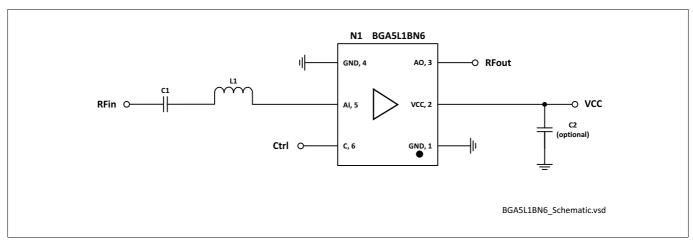


Figure 2 **Application Schematic BGA5L1BN6**

Bill of Materials Table 5

Name	Value	Package	Manufacturer	Function
C1	1nF	0402	Various	Input matching
C2 (optional)	≥ 1nF	0402	Various	RF bypass 1)
L1	11nH	0402	Murata LQW15 type	Input matching
N1	BGA5L1BN6	TSNP-6-10	Infineon	SiGe LNA

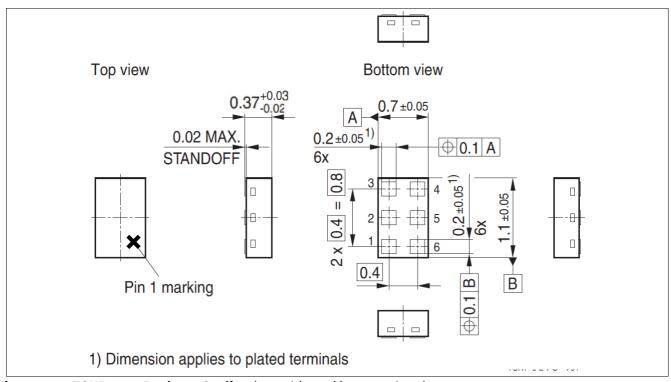
¹⁾ RF bypass recommended to mitigate power supply noise

A list of all application notes is available at http://www.infineon.com/ltelna



Package Information

Package Information 5



TSNP-6-10 Package Outline (top, side and bottom views) Figure 3

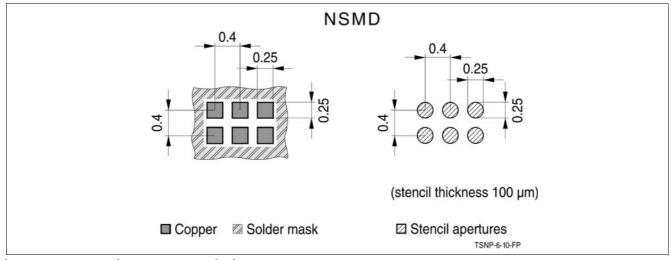


Figure 4 **Footprint Recommendation TSNP-6-10**



Package Information

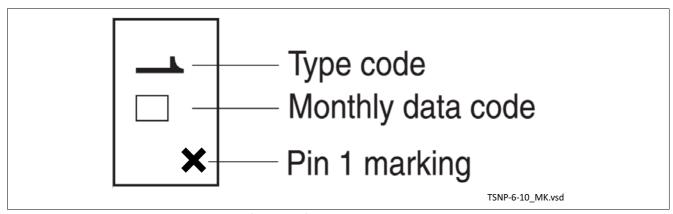


Figure 5 Marking Layout TSNP-6-10 (top view)

Month	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026
01	а	D	Α	Р	a	D	Α	P	a	D	A	Р
02	Ь	q	В	Q	Ь	q	В	Q	Ь	q	В	Q
03	С	Γ.	C	R	С	Г.	C	R	С	r r	C	R
04	В	S	D	S	d	S	D	S	В	S	D	S
05	e	t	Е	T	е	t	E	T	e	t	E	T
06	f	U	F	U	f	u	F	U	f	U	F	U
07	g	٧	G	V	g	V	G	V	g	V	G	V
08	h	×	Н	X	h	×	Н	X	h	Χ	Н	Χ
09	j	у	J	Υ	j	у	J	Y	j	У	J	Y
10	k	Z	K	Z	k	Z	K	Z	k	Z	K	Z
11	l	2	L	4	Į	2	L	4	l	2	L	4
12	П	3	N	5	n	3	N	5	П	3	N	5

Figure 6 Date Code Marking TSNP-6-10

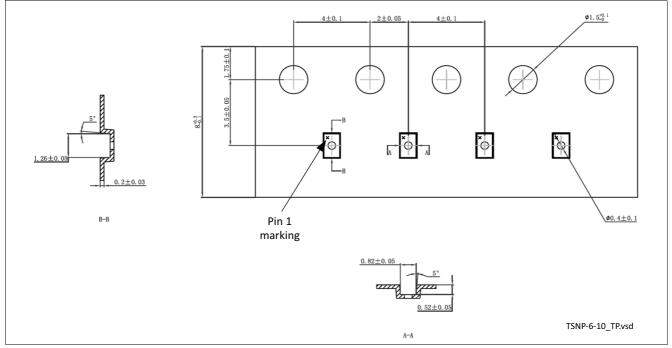


Figure 7 Tape & Reel Dimensions TSNP-6-10 (reel diameter 180 mm, pieces/reel 12000)

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Revision History								
Page or Item	Subjects (major changes since previous revision)							
Revision 2.0, 20	18-03-15							
all	Update Package Information							
5	Update Maximum Ratings							

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